uClamp0504T Low Profile µClamp® 4-Line ESD Protection

PROTECTION PRODUCTS - MicroClamp®

Description

The $\mu Clamp^{\circledast}$ series of TVS arrays are designed to protect sensitive electronics from damage or latch-up due to ESD. It is designed to replace single line devices such as multilayer varistors (MLVs) in space constrained applications such as cell phones, notebook computers, and other portable electronics. It features large cross-sectional area junctions for conducting high transient currents. TVS diodes offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The μ Clamp®0504T is in a 6-pin SLP1313P6T package. It measures 1.3 x 1.3 mm with a nominal height of only 0.4mm. The leads are spaced at a pitch of 0.4mm and are finished with lead-free NiPdAu. Each device features four TVS diodes with an operating voltage of 5 volts and a maximum loading capacitance of only 10pF.

They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge). The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and notebook computers.

Features

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-4 (EFT) 40A (tp = 5/50ns) Cable Discharge Event (CDE)
- Ultra-small package
- Protects four data lines
- Low clamping voltage
- Working voltage: 5V
- Low capacitance (10pF)
- Solid-state silicon-avalanche technology

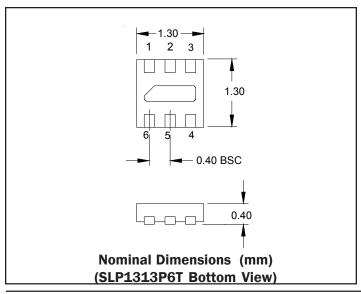
Mechanical Characteristics

- ◆ SLP1313P6T package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 1.3 x 1.3 x 0.4 mm
- Lead Finish: NiPdAu
- Molding compound flammability rating: UL 94V-0
- Marking : Marking code
- Packaging : Tape and Reel

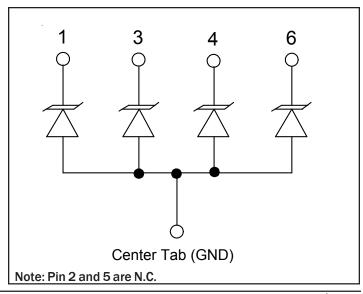
Applications

- Cellular Handsets & Accessories
- ◆ Notebooks & Handhelds
- mp3 Players
- Cordless Phones
- Portable Instrumentation
- Digital Cameras
- Peripherals

Dimensions



Schematic





Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P _{pk}	25	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I _{pp}	2	Amps
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	+/- 20 +/- 15	kV
Operating Temperature	T _J	-55 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

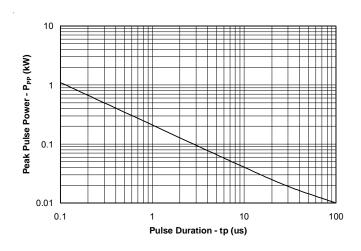
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}				5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA	6			V
Reverse Leakage Current	I _R	V _{RWM} = 5V, T=25°C			0.25	μΑ
Forward Voltage	V _F	I _F = 10mA		1	1.2	V
Clamping Voltage	V _c	$I_{pp} = 2A, t_p = 8/20\mu s$			12.5	V
Junction Capacitance	C _j	V _R = OV, f = 1MHz			10	pF
Junction Capacitance	C _j	V _R = 3.3V, f = 1MHz		4.5		pF

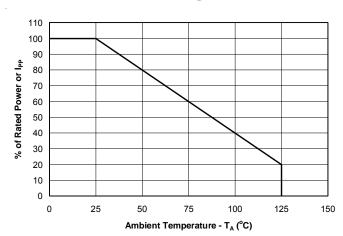


Typical Characteristics

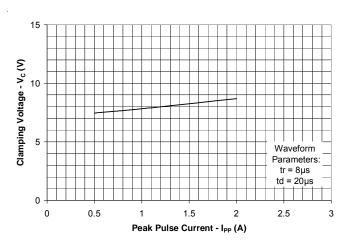
Non-Repetitive Peak Pulse Power vs. Pulse Time



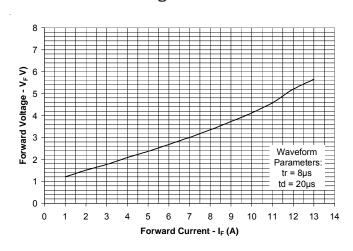
Power Derating Curve



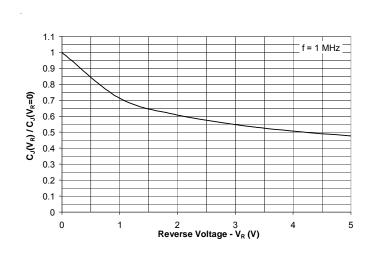
Clamping Voltage vs. Peak Pulse Current



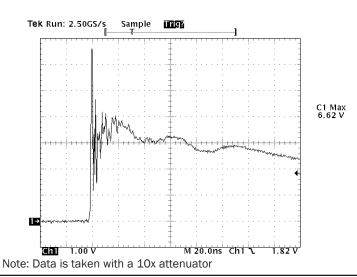
Forward Voltage vs. Forward Current



Normalized Junction Capacitance vs. Reverse Voltage



ESD Clamping (8kV Contact per IEC 61000-4-2)





Applications Information

Device Connection Options

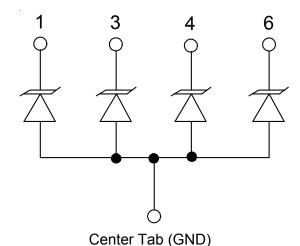
This device is designed to protect four data lines. The device is unidirectional and may be used on lines where the signal polarity is above ground.

Circuit Board Layout Recommendations for Suppression of ESD.

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

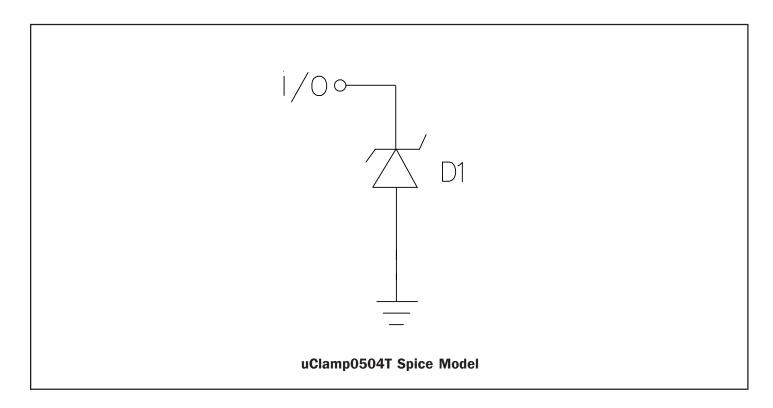
Circuit Diagram



Note: Pin 2 and 5 are N.C.



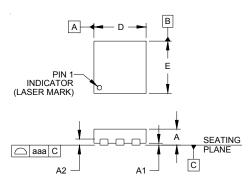
Applications Information - Spice Model



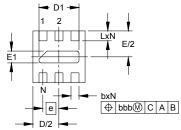
uClamp0504T Spice Parameters							
Parameter	Unit	D1 (TVS)					
IS	Amp	2.05e-15					
BV	Volt	7.0					
٧J	Volt	0.80					
RS	Ohm	0.75					
IBV	Amp	1.0E-3					
C10	Farad	9e-12					
TT	sec	2.541E-9					
М		0.25					
N		1.1					
EG	eV	1.11					



Outline Drawing - SLP1313P6T



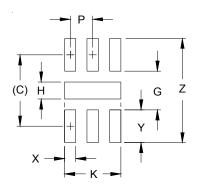
	DIMENSIONS								
DIM		NCHE		MILLIMETERS					
DIIVI	MIN	NOM	MAX	MIN	NOM	MAX			
Α	.015	.016	.017	0.37	0.40	0.43			
A1	0.00	.001	.002	0.00	0.03	0.05			
A2		(.005)			(0.13)				
b	.006	.008	.010	0.15	0.20	0.25			
D	.047 .051		.055	1.20	1.30	1.40			
D1	.035 .039		.043	0.90	1.00	1.10			
E	.047 .051		.055	1.20	1.30	1.40			
E1	.008	.012	.016	0.20	0.30	0.40			
е	.016 BSC			0.40 BSC					
L	.008	.010	.012	0.20	0.25	0.30			
N		6		6					
aaa		.003		0.08					
bbb		.004		0.10					



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Land Pattern - SLP1313P6T



	DIMENSIONS							
DIM	INCHES	MILLIMETERS						
С	(.050)	(1.27)						
G	.027	0.69						
Н	.012	0.30						
K	.039	1.00						
Р	.016	0.40						
X	.008	0.20						
Υ	.023	0.58						
Z	.073	1.85						

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
- 3. THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.



Marking Code



YW = Date Code

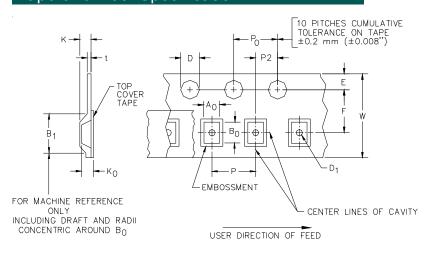
Ordering Information

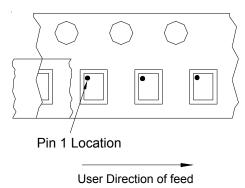
Part Number	Working	Qty per	Reel	
	Voltage	Reel	Size	
uClamp0504T.TCT	5V	3,000	7 Inch	

Notes:

1) This is a lead-free, RoHS/WEEE compliant product MicroClamp, uClamp and μClamp are marks of Semtech Corporation

Tape and Reel Specification





Device Orientation in Tape

A0 B0		ко
1.51 +/-0.05 mm	1.51 +/-0.05 mm	0.56 +/-0.05 mm

Tape Width	B, (Max)	D	D1	E	F	K (MAX)	Р	PO	P2	T(MAX)	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 000)	0.8 mm ±0.05 (.031)	1.750±.10 mm (.069±.004)	3.5±0.05 mm (.138±.002)	2.4 mm (.094)	4.0±0.1 mm (.157±.00- 4)	4.0±0.1 mm (.157±.00- 4)	2.0±0.05m- m (.079±.002)	0.4 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

Semtech Corporation Protection Products Division 200 Flynn Rd., Camarillo, CA 93012 Phone: (805)498-2111 FAX (805)498-3804

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P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327
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